polyimide, polyimide siloxane, polysilsequioxane polymer, benzocyclobutene, paralyene,

polyolefin, poly-naphthalene, fluropolymer resin, polyphenylene oligomer, methane doped silica,

polymer foam and aerogel.

21.-29. (Cancelled)

REMARKS

Favorable consideration and allowance of the claims of the present application, as

amended herein, is respectfully requested.

In this preliminary amendment, applicants have cancelled original Claim 1-9 and 21-29,

since those claims are subject matter of co-pending application U.S. Serial No. 09/684,000, filed

March 11, 2002. Applicants have also amended the specification to include reference to the

parent application.

Since the above amendments to the claims and specification do not introduce new matter

into the application, entry thereof is respectfully requested.

Consideration and allowance of the claims of the present application are thus respectfully

requested.

Respectfully submitted,

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